

ASSEMBLED PRODUCT TO BE RoHS COMPLIANT USING SAC305 LEAD-FREE SOLDER

REV.	REVISION DESCRIPTION	DATE	BY	ECO
A		2/10/94		
B	SUPPLIED SCREW WAS CALLE DOUT	5/3/94		
C	L200.2	7/1/96		
D	ADD AMAC150.7	5/1/97		
E	MAC200.4 WAS MAC150.2	7/27/99		
F	ADDED DIE CUT FOAM PARTS MAC200.9, 10	3/25/2008	CT	3649
G	ADDED CAL200.F-NTI & ADDITIONAL ASSEMBLY NOTES	9/28/2010	JWH	3959
H	ADDED INFORMATION FOR RoHS COMPLIANCE	5/11/2017	DWA	4562
I	EDITED INSTRUCTIONS FOR MAC200.11 PART NUMBER CREATION	8/28/2018	DPW	4733
J	CHANGED 0285.0016 TO 0285.0024	2/26/2019	DCW	4785

P/N	DESCRIPTION	REV	SHEET
CAL150.F	ASSEMBLED CAL150 W/O PACKAGING	J	2
CAL200.F	ASSEMBLED CAL200 W/O PACKAGING	J	3
CAL200.F-NTI	ASSEMBLED CAL200-NT W/O PACKAGING	I	3
S200	SUBASSY CALIBRATOR RoHS CAL150 & CAL200	J	3



TITLE		ASSEMBLED, CAL 150/200 W/O PACKAGING	
SIZE	NUMBER	REV.	
B	CALXXX.F	J	
SCALE 1:2	SHEET 1 OF 3		

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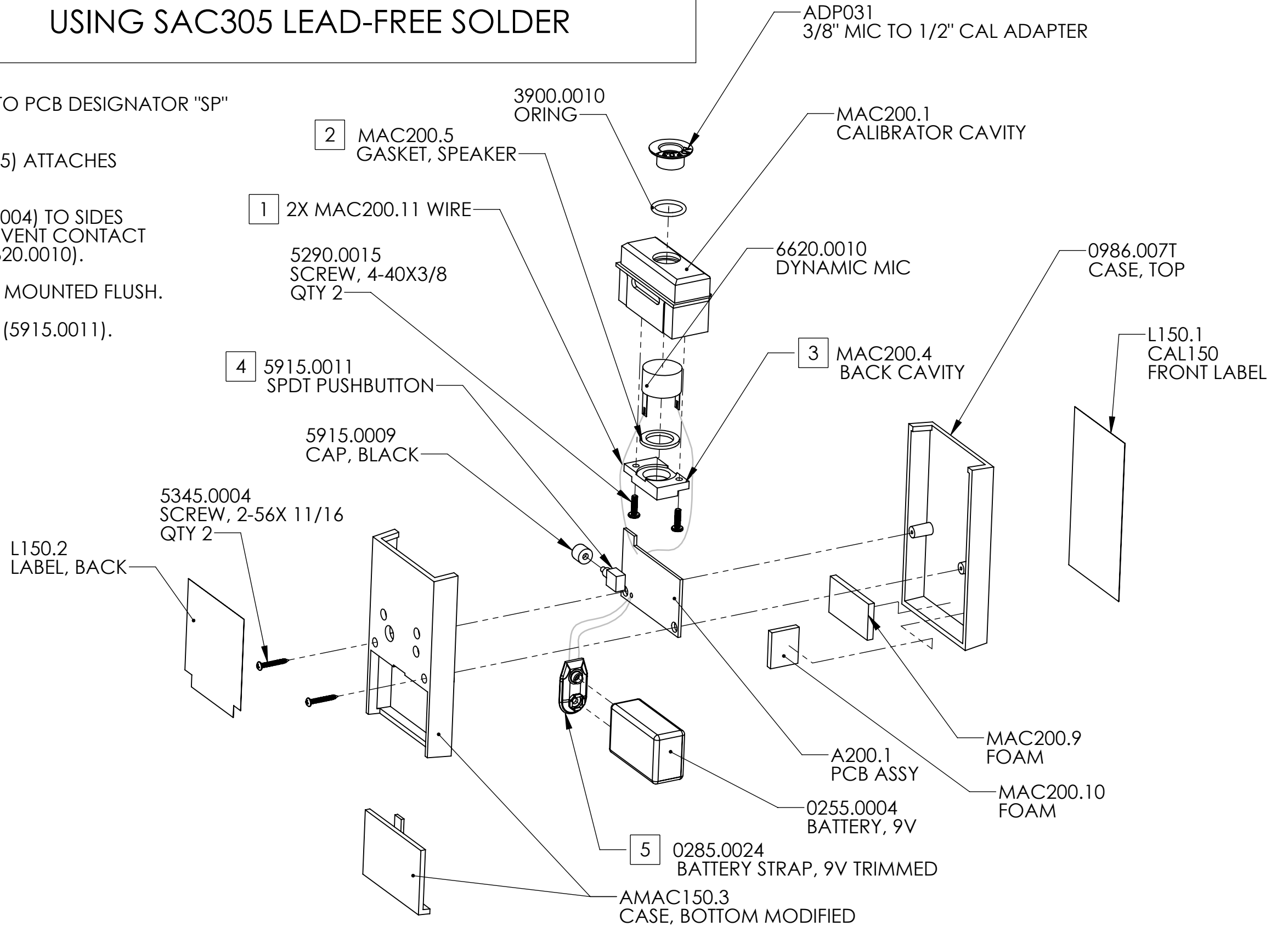
AUTHOR
LEROY H
DATE
2/10/1994

TEMPLATE: D2140-0023 [1]

ASSEMBLED PRODUCT TO BE RoHS COMPLIANT
USING SAC305 LEAD-FREE SOLDER

NOTES:

- 1 SOLDER MAC200.11 SPEAKER WIRES TO PCB DESIGNATOR "SP" ON EACH SIDE OF A200.1 BOARD.
- 2 ADHESIVE SIDE OF GASKET (MAC200.5) ATTACHES TO DYNAMIC MIC (6620.0010).
- 3 ADD TAPE (FLOOR STOCK P/N 6075.0004) TO SIDES OF BACK CAVITY (MAC200.4) TO PREVENT CONTACT WITH LEADS FROM DYNAMIC MIC (6620.0010).
- 4 SOLDER TO PCB USING FIXTURE, NOT MOUNTED FLUSH.
- 5 ATTACH TO PCB AFTER PUSHBUTTON (5915.0011).

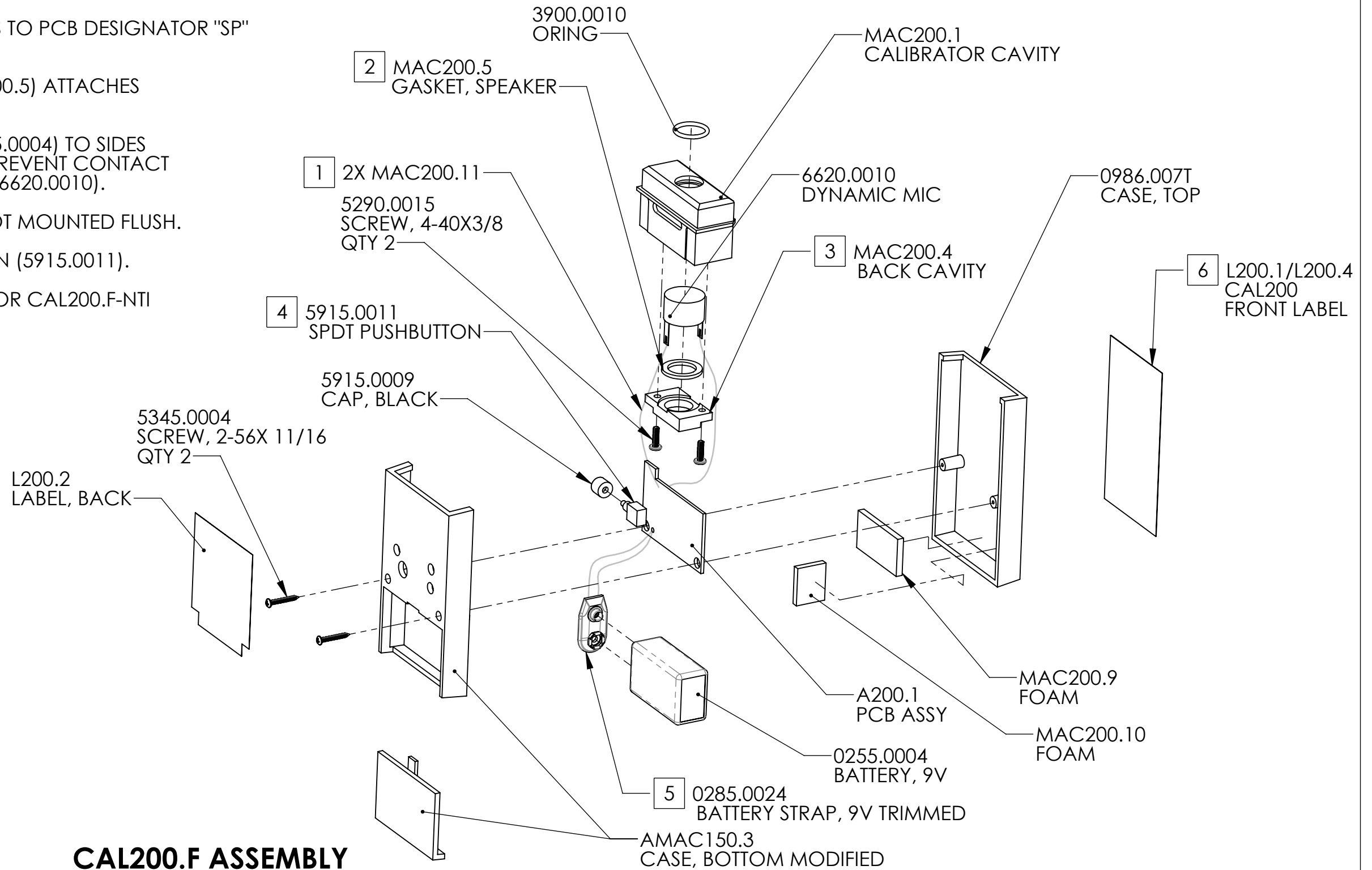


CAL150.F ASSEMBLY

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- 2 ADHESIVE SIDE OF GASKET (MAC200.5) ATTACHES TO DYNAMIC MIC (6620.0010).
- 3 ADD TAPE (FLOOR STOCK P/N 6075.0004) TO SIDES OF BACK CAVITY (MAC200.4) TO PREVENT CONTACT WITH LEADS FROM DYNAMIC MIC (6620.0010).
- 4 SOLDER TO PCB USING FIXTURE, NOT MOUNTED FLUSH.
- 5 ATTACH TO PCB AFTER PUSHBUTTON (5915.0011).
- 6 FOR CAL200.F USE L200.1 LABEL.. FOR CAL200.F-NTI USE L200.4 LABEL.



**CAL200.F ASSEMBLY
CAL200.F-NTI ASSEMBLY
S200 ASSEMBLY**